Electronic Patent Application Fee Transmittal							
Application Number:	10681983						
Filing Date:	09-	09-Oct-2003					
Title of Invention:	MULTIPLE LEADFRAME LAMINATED IC PACKAGE						
First Named Inventor/Applicant Name:	Chun Ho Fan						
Filer:	Johnathan Bockman/Kathleen Libby						
Attorney Docket Number:	618902001410						
Filed as Large Entity							
Utility under 35 USC 111(a) Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Utility Appl issue fee		1501	1	1440	1440		
Extension-of-Time:							

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)				
Miscellaneous:								
Printed copy of patent - no color	8001	6	3	18				
	Tot	1458						